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Studies of structural and electrical properties of La-Mg-Mn-Ti-O ceramic

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The samples with chemical formula $La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O_3$ (x = 0.30, 0.40 and 0.50) were synthesized using solid-state reaction method. XRD of the samples shown the samples pattern attributed to the cubic structure with 'a' = 3.8943 and its space group Pm3m. The SEM images display microstructure of the sample were porous and the grains are merged with unequal sizes distributed inhomogeously throughout the samples with irregular boundaries. The sample of x = 0.4 was the most porous than the others. The electrical properties were measured using LCR meter with the frequency range from 0.01 Hz until 100 KHz and in a temperature range of 313 K until 373 K. The electrical properties of the samples were study by analyzed the dielectric constant, ε ', dielectric loss, ε ", and tan δ . The results for dielectric constant and dielectric loss showed the higher values were located at lower frequency region which suggest that the samples were having interfacial polarization. Tan δ shows the lower value at higher frequency and lower temperature. By doping Mg, it decreases the dielectric loss and increasing the Mg doping it increases the dielectric constant.

Keywords: Mg²⁺ Doping, Dielectric, Ceramic, Solid state reaction method.

Introduction

Ceramics are well known due to their characteristics such as the ability to prevent corrosion, steady chemically, high melting points, and non-conductors of heat and electricity. Advanced ceramics are massproduced to be used in electrical components, hightemperature applications, and in body-worn armor [1]. As reported by Das et al, the classification of ceramics is according to their compositions as oxides, carbides, nitrides, and Borides [2]. As one of the most important structural ceramics, Aluminum oxide (Al₂O₃) is used as an electrical insulator and biocompatible medical devices, as well as applied for technical uses as a result of its high chemical and thermal resistance [3]. To have the robustness and notable refractoriness type of ceramic composite, this requirement can be met using light elements such as Be, B, N, O, Mg and Al because performable ceramics have one or more of the stated elements to be constituents [4, 5] such as MgTiO₃. As a microwave dielectric material, Magnesium titanate (MgTiO₃) ceramic has a dielectric constant as high as 17, a quality factor value as high as 160 000 GHz, and a resonance frequency temperature coefficient, $\tau_{\rm f}$ indicating a negative value (-50×10^{-6}) [6]. It has

been found that MgTiO₃ also has low dielectric loss and had been used as dielectric resonators in integrated circuits for wireless networks, global positioning systems, and mobile phones [7]. The crystalline system for pure MgTiO₃ is Hexagonal space group R3 and known for the ilmenite structure of MgTiO₃ with lattice parameters, a = 5.05 Å and c = 13.86 Å [8-10]. Another Mg base compound, LaTiMgO₃ shows low-loss dielectric material and has a distorted cubic structure [11]. From report by Zhao et al., by doping 0.005LaTi_{0.5}Mg_{0.5}O₃ to (Bi_{0.5}Na_{0.5})TiO₃.(Sr_{0.7}Bi_{0.3})TiO₃, leads to stable dielectric constant (2170±15%) at high-temperature range of 35-363 °C [12]. From Yang et al., studies, fabrication of La_{1-x}Mg_xTiO₃ by solid state method, shows the composites is preferable for industrial applications as high temperature negative temperature coefficient (NTC) thermistors over a 400-1200 °C [13]. Oxides based on LaMnO₃, are well-known for their ferromagnetic behavior as well for their giant-magnetoresistance [14]. It is known too that doped lanthanum manganite materials $R_{1-x}A_xMnO_3$ where R is a trivalent rare earth ion and A is a divalent ion are interesting because of its negative colossal magnetoresistance (CMR), magnetic transition, and metal-insulator phase transition [15]. $La_{1-x}Ca_x Mn_{1-y}Fe_yO_3$ (x=0.37,0.53 y=0.2) was found to have suppression of ferromagnetism and metallic conduction in the compound due to the presence of Fe [16]. Introduction of tetravalent Ti ion at B-site of perovskite manganite, La_{0.1}Ca_{0.9}Mn_{1-x}Ti_xO₃ was been investigated affecting the transport properties and was

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found a weakening of the cation-anion-cation overlapping [17]. Thus, based on literature reviews, we conduct research in order to study the effect of adding Mg to the A-site of LaMnTiO₃ material; La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O₃ (x = 0.30, 0.40, and 0.50) and study its structural and electrical properties in temperature of 40 °C until 200 °C. The electrical statistics were analyzed in complex permittivity, and tan δ . It is expected by doping Mg would decrease the dielectric loss and increasing Mg doping would increase the dielectric constant.

Materials and Methods

Solid-state reaction method were used with high quality oxide powder; lanthanum oxide, La₂O₃ (CAS No.: 1312-81-8), magnesium oxide, MgO (CAS No.: 1309-48-4), manganese oxide, MnO₂ (CAS No.: 1313-13-9), and titanium oxide, TiO₂ (CAS No.: 13463-67-7) to create $La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O_3$ where composition x = 0.30, 0.40, and 0.50. The samples preparation is following the method in previous preparation of $La_{1-x}Sr_xMn_{0.4}Ti_{0.6}O_3$ [18, 19] and $La_{0.70}Ba_{0.30}Mn_{0.40}Ti_{0.60}O_3$ [20]. The stoichiometric ratios of the reactant required were weighed accordingly and then mixed with distilled water as their medium for 24 hours. The samples goes for the drying process in 48 hours at temperature of 80 °C and afterward grounded for 30 minutes. The calcination was performed in two stages where first stage of calcination started at 800 °C for 12 hours and the second stage at 1000 °C for 12 hours, before sintered at 1200 °C for 12 hours. Half of the samples were in pellet form and half of it in powder form. Fig. 1 shows what the final sample will look like.

The sample in powder form was used for XRD analysis while the pellet sample was for dielectric measurement. As for SEM analysis, a small fracture of the pellet was used. The characterization analysis for their crystalline phase exist in the sample was carried out using the X-ray powder diffractometer, Phillips PW 3040/60 X'pert Pro (λ_{Cu} =1.5406 Å) with a scanning angle of 20°-80° at room temperature. As for the surface morphology of the samples has been studied using Scanning Electron Microscope, JEOL JSM-6390. Inductance-capacitance-resistance LCR meter, Hioki 3522-50 LCR HiTESTER was used to measure the

electric properties of capacitance (C) and conductance (G) with the frequency range set up from 0.01 Hz until 100 kHz and in a temperature range of 40 °C until 200 °C. The pellet dimension for dielectric analysis is measured by calculation in Equation (1) where ε_0 permittivity free space, A surface area range; (5.62- $(7.76) \times 10^{-5} \text{ m}^2$ and d thickness range; (0.002-0.003) mof pellet. From the result of the LCR meter, the data then be transformed into permittivity values to find out their electrical properties. To support the SEM analysis, samples density and average particle size of the samples also been studied. The sample density was determined using the Archimedes method. The pellets were submerged into distilled water and the changes in water volumes ΔV , and masses Δm were recorded. The average particle size was gathered using a linear intercept method and can be seen in Table 2.

$$C_o = \frac{\varepsilon_{0.A}}{d} \tag{1}$$

Results and Discussion

After fabrication of $La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O_3$ (x = 0.30, 0.40 and 0.50) samples using solid-state method, structural and electrical analysis were performed. X-ray diffraction showed the sample's lattice structure. From Fig. 2, by using CHECKCELL software, the sample's crystalline system is in a cubic structure with a space group of Pm3m. The finding of the patterns can be found similar to SrTiO₃ [21], (La_{0.4}Ba_{0.4}Ca_{0.2}) Mn_{0.4}Ti_{0.6}O₃ [22], and $La_xSr_{1-x}TiO_3$ (x = 0.0-0.4) [23]. There is the existence of a few peaks from the presence of reactants which is the existence of La₂Ti₂O₇ [24]. The second phase increases as the Mg content increase. The values of lattice parameter and structure volume were tabulated in Table 1. The lattice parameter, a=b=c decreases as the Mg content increase and this shows that there is the rearrangement of the atoms in the lattices [24]. The same goes to its unit cell volume to decrease as the Mg content increase due to the replacement of the small size of Mg²⁺ ions (72 pm) [25] by larger size La³⁺ ions (103.2 pm) at the A-site of the sample structure [23].

Fig. 3(a-c) shows SEM images exhibit microstructure of the sample were porous and the grains are merged

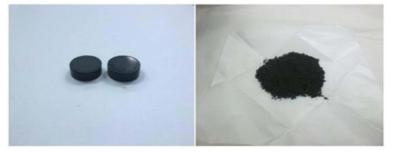


Fig. 1. Form of samples in pellet and powder.

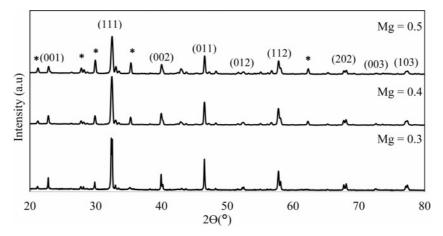


Fig. 2. X-ray diffraction patterns of $La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O_3$ samples (Mg composition, x = 0.3, 0.4 and 0.5). The asterisk '*' indicates the secondary phase.

Table 1. Cell parameters for La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O₃.

Mg	Lattice parameter	Volume, V
composition	Lattice parameter, a = b = c (Å)	(Å ³)
0.30	3.8985	59.249
0.40	3.8926	58.982
0.50	3.8919	58.952

with unequal sizes distributed inhomogeneously throughout the samples with irregular boundaries. Although the sizes of the samples were different from each other, the difference was small. For sample x =0.4, it seems more porous than x = 0.3 and 0.5. This is proven by sample density in Table 2 where sample x =0.4 is the lowest among the three samples which shows the samples are less dense. The sizes of the particles

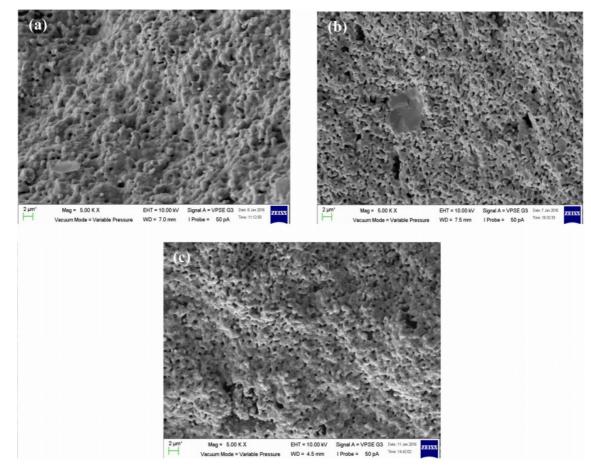


Fig. 3. The SEM images of $La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O_3$ where composition x = (a) 0.30, (b) 0.40, and (c) 0.50.

Mg composition	Average particle size, L _{particle} (µm)	Sample density, $\rho_{sample} (kgm^{-3})$
0.30	1.263	700
0.40	0.972	630
0.50	0.851	710

Table 2. Particle size and density analysis of $La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O_3$.

are aligned with the appearance in Fig. 3(a-c). Even though the density of the sample in Fig. 3(b) has less density, the average particle size is bigger than in Fig. 3(c) due to some of the particles merging and melting to form bigger particles. There is more void space between the grains and this fact supported the sample x = 0.4 is more porous than other samples.

For electric properties, the data gained from the LCR meter which is capacitance (c) and conductance (G) were transformed into permittivity, ε^* , and is shown in equation 2. Permittivity analysis is an analysis to know the ability of a material to polarize in the electric field. The real part, ε ' is known as the dielectric constant and is shown in Fig. 4(a-c) while the imaginary part, ε '' is for dielectric loss of the sample shown in Fig. 5(a-c). For Fig. 4(a-c), the dielectric constant decreases as frequency increases in all temperatures due to dielectric dispersion [26]. This phenomenon can be explained based on space charge polarization largely eased by the

movement of free space charge carriers in the form of Mn^{+3} and Mn^{+4} [26, 27]. The highly steep of dielectric constant in Fig. 4(a-b) at the frequency range 0.01 Hz-1 Hz is due to interfacial polarization that could happen because of inhomogeneities where the hoping electron are trapped [28]. At a certain frequency range of 1 Hz until 1 kHz, the value of ε ' is in plateau form due to the polarization phenomenon where the samples maintain the charges separation. As the temperature increased, the plateau condition also shifted to a higher frequency area which shows that the charge separation maintain at higher frequency. As in Fig. 4(c), ε ' decreases linearly as the frequency increase. The condition was due to polarization mechanisms no longer being able to follow the rapidly changing field which shows that the samples are having dielectric relaxation. As the temperature increase from 40 °C to 200 °C, the value of ε ' increases. The increment of ε ' with temperature could be due to enhanced drift velocity caused due to the thermal activation of hopping of the electrons [29]. It is clearly showing that the space charge polarization occurs at lower frequency and as the temperature increase, it influences the dielectric constant of all the samples. The dielectric constant decreases at frequency range after 1 kHz until 100 kHz is due to electronic polarization [30]. Dielectric loss derives from leakage conductivity, dielectric relaxation or intrinsic loss [31].

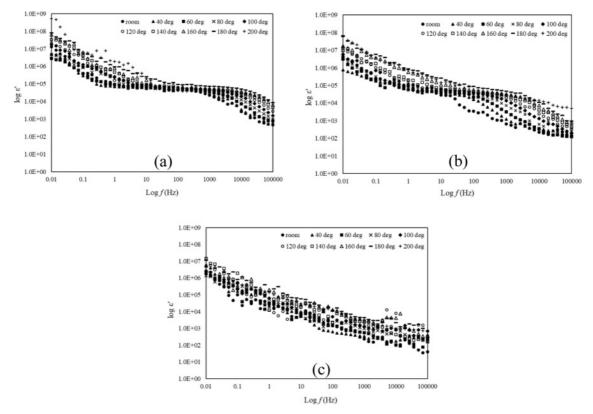


Fig. 4. log ε ' versus log f of La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O₃ where composition x = (a) 0.30, (b) 0.40, and (c) 0.50 with temperature range from room until 200°C.

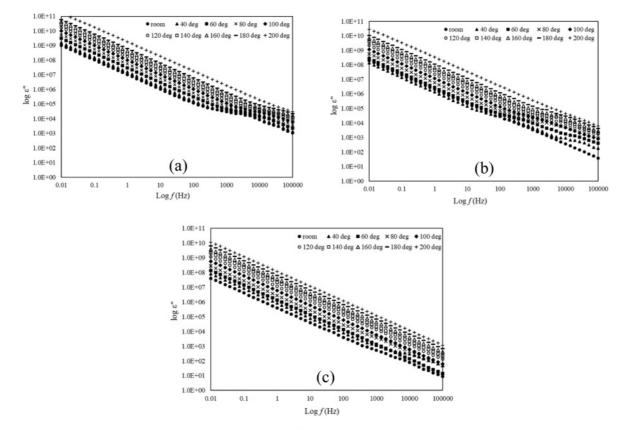


Fig. 5. log ε " versus log *f* of La_{*l-x*}Mg_{*x*}Mn_{0.4}Ti_{0.6}O₃ where composition x = (a) 0.30, (b) 0.40, and (c) 0.50 with temperature range from room until 200°C.

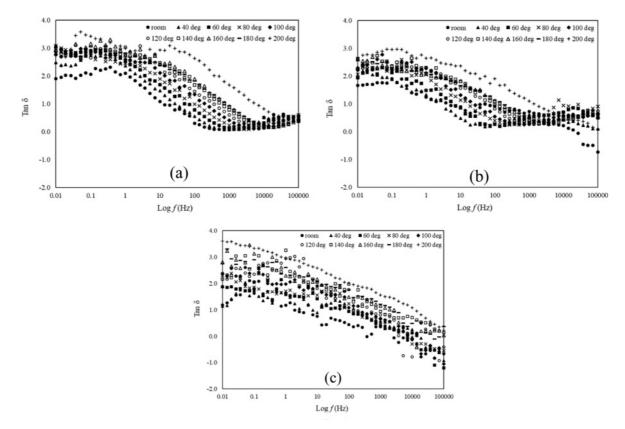


Fig. 6. Tan δ versus log *f* of La_{*l*-*x*}Mg_{*x*}Mn_{0.4}Ti_{0.6}O₃ where composition *x* = (a) 0.30, (b) 0.40, and (c) 0.50 with temperature range from room until 200°C.

$$\varepsilon^* = \frac{c^*}{c_o} \tag{2}$$

As for Fig. 5(a-c), the dielectric loss, ε " is linear with frequency with the slope is nearly -1 and this characteristic shows the samples are near d.c. conductivity [18]. At lower frequencies, dielectric loss for all samples shows higher value and increase as the temperature increases. At higher frequency between 1 kHz and 10 kHz the samples shown humps that is slowly disappear as the temperature increases. This is due to the interfacial polarization and the total charge carrier exaggerated as the temperature rise [32]. The humps also slowly dissapear as the Mg doping increases. This could be that Mg reduce the range between atoms consequently promotes change in mobility. The increase of dielectric loss as the frequency decrease may be due to the leak of conductance [33, 34].

Another way to get dielectric loss information is by plotting graph of tan δ against log f which are shown in Fig. 6(a-c). Tan δ shows the value of dissipation of electrical energy due to electrical conduction, dielectric relaxation, loss from non-linear processes and dielectric resonance. In this paper, the tan δ value having plateau stage from 0.01 Hz until 1 Hz in all samples. Then it started to decrease rapidly from frequency range 1 Hz until 100 Hz and it is shifted to higher frequency as the temperature increases. High value of tan δ shows that the samples having more dielectric loss primarily due to the polarisation of the dielectric lagging behind the applied field, which causes an interaction between the field and polarisation, which in turn causes heating. For application reason, lower tan δ values are desired.

Conclusion

The samples $La_{1-x}Mg_xMn_{0.4}Ti_{0.6}O_3$ (x = 0.30, 0.40 and 0.50) were fabricate by using solid-state method. X-ray diffraction data confirmed its crystalline system is in a cubic structure with a space group of Pm3m. The SEM images exhibit microstructure of the samples was porous, and the grains are merged with unequal sizes distributed inhomogeneously throughout the samples with irregular boundaries. The dielectric constant of all samples at low-frequency range 0.01 Hz until 1 Hz are affected by interfacial polarization while at high-frequency range 1 kHz until 100 kHz was due to electronic polarization. The dielectric constant of all the samples is thermally activated. As for dielectric loss, it increases as the frequency decrease due to leakage of conductivity. From the tan δ graph, the value seems decreases as the frequency increase and it shows that at a lower temperature the sample is preferable for electronic device such as capacitor at lower frequency.

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